

Temperature Range - Operating Termination Interface: Style

This document was generated on 01/17/2022 PLEASE CHECK WWW.MOLEX.COM FOR LATEST PART INFORMATION

Part Number: 0	736421200		6 V.	
	ctive		the test	ч.
Overview: HDM Backplane Co		ten Ountern	2	Serve .
				. The age
Description: H	DM Board-to-Board Ba	ckplane Header, Vertical, Press-Fit, Open End, 144 Circuits		the tere
Documents:				llos de
3D Model		Product Specification PS-73670-9999-001 (PDF)	~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~	
3D Model (PDF)		Packaging Specification PK-70873-0818-001 (PDF)	44-2	
Drawing (PDF)		RoHS Certificate of Compliance (PDF)		
Agency Certification			Series imag	ge - Reference only
CSA		LR19980		
UL		E29179	EU ELV	
01		220110	Not Relevant	
General			Not Kelevalit	
Product Family		Backplane Connectors	EU RoHS	China RoHS
Series		<u>73642</u>	Compliant	
Application		Backplane	REACH SVHC	
Comments		Standard Press-Fit	Not Contained Per	-
Component Type		PCB Header	D(2021)4569-DC (8
Overview		HDM Backplane Connector System	July 2021)	
Product Name		HDM	Halogen-Free	
UPC		800754345132	Status	
			Low-Halogen	
Physical				on, please visit <u>Contact l</u>
Circuits (Loaded)		144		, predee men <u>e emaer</u>
Circuits (maximum)		144	China ROHS	Green Image
Color - Resin		Black, Natural	ELV	Not Relevant
Durability (mating cycles max)		250	RoHS Phthalates	Not Contained
First Mate / Last Break		No		
Flammability		94V-0		
Guide to Mating Part		No	Convola Dovto in	this Carias
Keying to Mating Part		None	Search Parts in	this Series
Material - Metal		Phosphor Bronze	73642 Series	
Material - Plating Mating		Gold		
Material - Plating Termination		Gold	Mates With	
Material - Resin		High Temperature Thermoplastic	73632 HDM+ Board-to-Board Daughter	
Net Weight		6.705/g	Receptacle. 73780 HDM Board-to-Board	
Number of Columns		24	Daughtercard Re	eceptacle
Number of Pairs		Open Pin Field		
Number of Rows		6	Application Too	ling <u>FAQ</u>
Orientation		Vertical		tions and manuals are
PC Tail Length		3.50mm		g the products below.
PCB Locator		No		ecifications are then
PCB Retention		None		Application Tooling
PCB Thickness - Recomm	nended	1.60mm	Specification doc	
Packaging Type		Tube	Global	
Pitch - Mating Interface		2.00mm	Description	Product #
Pitch - Termination Interface		2.00mm	Extraction Tool 621001000	
Plating min - Mating		0.762µm		021001000
Plating min - Termination		0.051µm		
Polarized to PCB		No		
Stackable		Yes		
Surface Mount Compatibl	e (SMC)	Yes		
Temperature Range - Op		-55° to +105°C		

Yes -55° to +105°C Through Hole - Compliant Pin

Electrical			
Current - Maximum per Contact	1.0A		
Data Rate	1.0 Gbps		
Real Signals (per 25mm)	75		
Shielded	No		
Voltage - Maximum	250V AC		
Solder Process Data Lead-freeProcess Capability	N/A		
Material Info			
Reference - Drawing Numbers			
Packaging Specification	PK-70873-0818		
Product Specification	PS-73670-000		

Product Specification Sales Drawing PK-70873-0818-001 PS-73670-9999-001 SDA-73642-XXXX-001, SDA-73642-XXXX-002

This document was generated on 01/17/2022 PLEASE CHECK WWW.MOLEX.COM FOR LATEST PART INFORMATION

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for High Speed/Modular Connectors category:

Click to view products by Molex manufacturer:

Other Similar products are found below :

650827-1 74040-1346 1410191-1 1410337-1 1410368-3 1410964-2 1410326-3 1410367-3 1410971-4 1467833-1 2000877-1 2000878-1 2041314-1 2065387-1 2187307-1 163P 1934290-1 2000875-1 2065917-1 2102736-2 FSR-40 2169868-2 22354-8 437-5040-000 5- 1393565-0 039-0246-000 0761601016 0784461022 10123159-12ELF 030-2415-003/100 PK 030-7380-004 030-2494-001 532939-1 5532901-3 3-1469268-7 74748-102LF 73670-0247 10041743-101LF 10066670-100002LF 1-533915-1 249-4515-000 7-1469373-3 DL2- 2J/S 2000713-8 2000713-7 10124313-101LF 3011-21 757105208 EBTF-4-10-2.0-S-RA-1 430305-001